

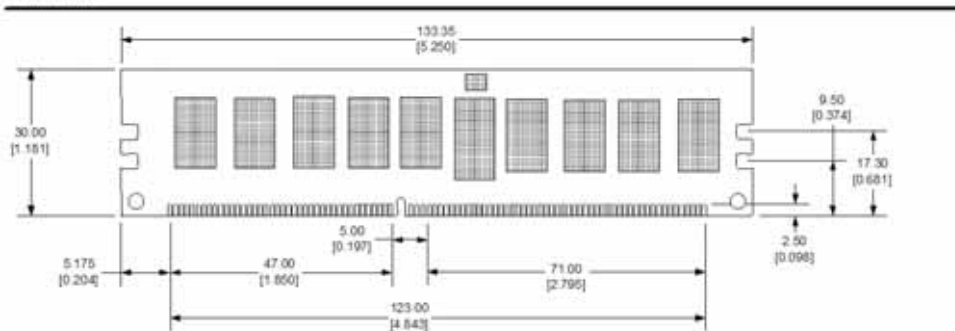
Products in Family

DRSX2270-13/2GB (1 x 2GB 1Rx4 DIMMs)
 DRSX2270-813/2GB (1 x 2GB 2Rx8 DIMMs)
 DRSX2270-13/4GB (1 x 4GB 2Rx4 DIMMs)
 DRSX2270-13/8GB (1 x 8GB 2Rx4 DIMMs)



Features		Description
240-pin JEDEC-compliant DIMMs 133.35 mm wide by 30 mm high (1.181" x 5.25") Data Transfer Rate: 10.6 Gigabytes/sec Operating Voltage: 1.5 V ±0.075 Fully RoHS Compliant Thermal Sensor		Each DRSX2270-13 upgrade consists of a single DDR3-1333 Registered ECC DIMM that conforms to JEDEC's DDR3, PC3-10600 standard. One 2K-bit EEPROM is used for Serial Presence Detect and a combination register/PLL with Address and Command Parity is also used. A thermal sensor accurately monitors the DIMM module and can prevent exceeding the maximum operating temperature of 95C.
Dataram Product	Sun Microsystems Product	Supported in these Sun Microsystems systems:
DRSX2270-13/2GB DRSX2270-813/2GB DRSX2270-13/4GB DRSX2270-13/8GB	X8337A Not Offered by Sun X8338A, X8359A Not Offered by Sun	Sun Fire X2270, X2270 M2

Front view

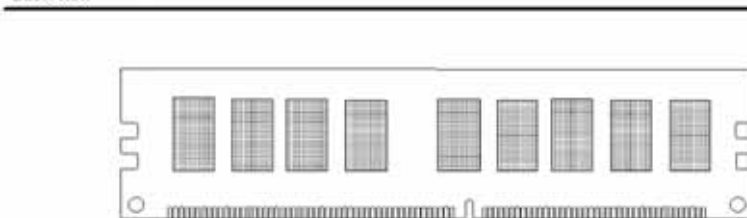


Notes

Tolerances on all dimensions except where otherwise indicated are \pm .13 (.005).

All dimensions are expressed in millimeters [inches]

Back view



Side view

